Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSVII)

# **TK11A50D**

#### **Switching Regulator Applications**

Low drain-source ON-resistance: R<sub>DS</sub> (ON) = 0.45 Ω (typ.)

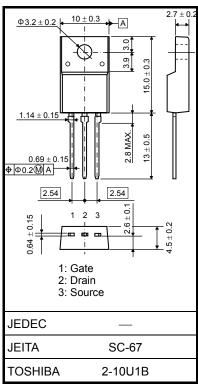
High forward transfer admittance: |Y<sub>fS</sub>| = 5.5 S (typ.)

• Low leakage current:  $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 500 \text{ V)}$ 

• Enhancement mode:  $V_{th}$  = 2.0 to 4.0 V ( $V_{DS}$  = 10 V,  $I_D$  = 1 mA)

### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	500	V	
Gate-source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC (Note 1)	I <sub>D</sub>	11		
	Pulse (t = 1 ms) (Note 1)	I <sub>DP</sub>	44	Α	
Drain power dissipati	on (Tc = 25°C)	P <sub>D</sub>	45	W	
Single pulse avalance	ne energy (Note 2)	E <sub>AS</sub>	264	mJ	
Avalanche current		I <sub>AR</sub>	11	Α	
Repetitive avalanche	energy (Note 3)	E <sub>AR</sub>	4.5	mJ	
Channel temperature	!	T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

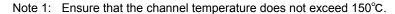


Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

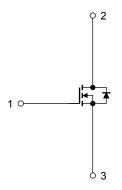
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.78	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W



Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}(\text{initial})$ , L = 3.7 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = 11 \text{ A}$ 

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Start of commercial production 2009-05

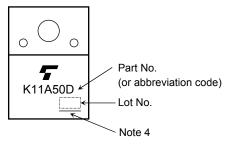
## **Electrical Characteristics (Ta = 25°C)**

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μΑ
Drain cut-off current		I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	10	μΑ
Drain-source breakdown voltage		V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold vo	oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source ON	-resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.5 A	_	0.45	0.6	Ω
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.5 A	1.4	5.5	_	S
Input capacitance		C <sub>iss</sub>		_	1200	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	6	_	
Output capacitance		Coss			120	_	
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $V_{OV}$ $V_{OV}$ $V_{OV}$ $V_{OV}$ $V_{DD} \approx 200 \text{ V}$ $V_{DD} \approx 200 \text{ V}$	_	25	_	
	Turn-on time	t <sub>on</sub>		_	60	_	
	Fall time	t <sub>f</sub>		_	12	_	ns
	Turn-off time	t <sub>off</sub>		_	100	_	
Total gate charge		Qg		_	24	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}$	_	16	_	nC
Gate-drain charge		Q <sub>gd</sub>		_	8	_	

## **Source-Drain Ratings and Characteristics (Ta = 25°C)**

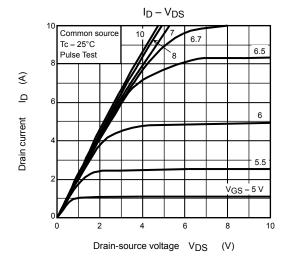
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	_	_	_	11	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	44	Α
Forward voltage (diode)	$V_{DSF}$	I <sub>DR</sub> = 11 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 11 A, V <sub>GS</sub> = 0 V,	_	1300	_	ns
Reverse recovery charge	Qrr	dI <sub>DR</sub> /dt = 100 A/μs		12	_	μС

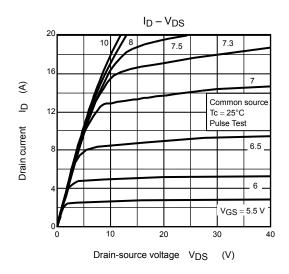
#### **Marking**

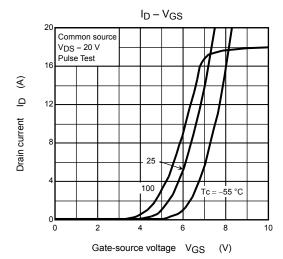


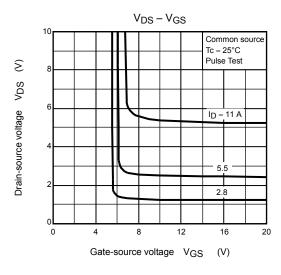
Note 4 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

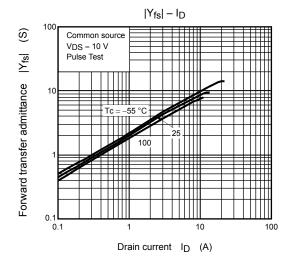
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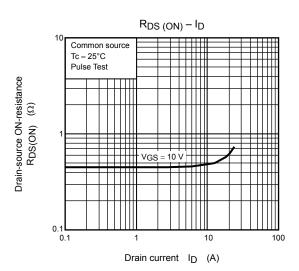




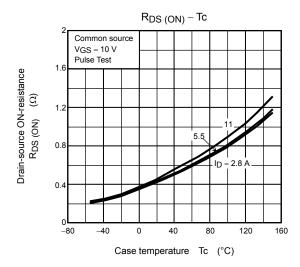


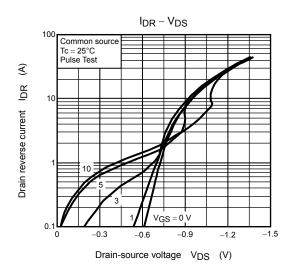


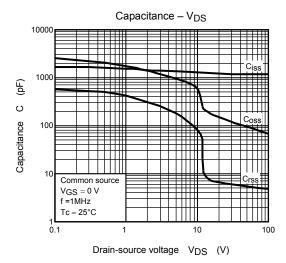


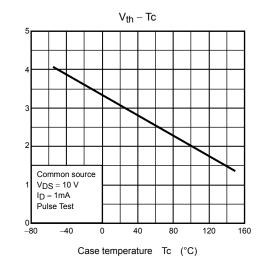


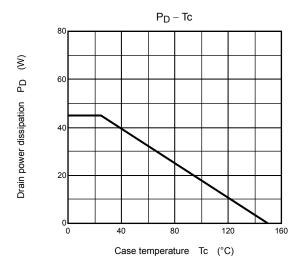
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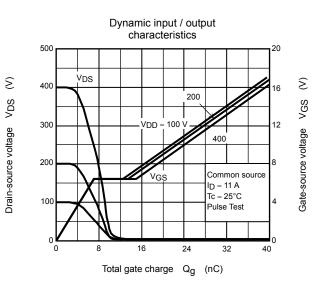








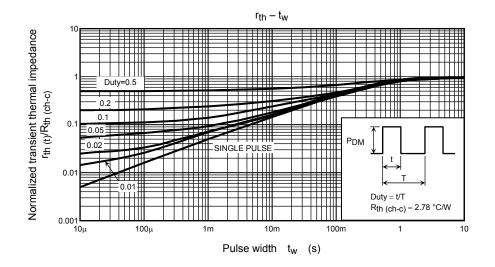


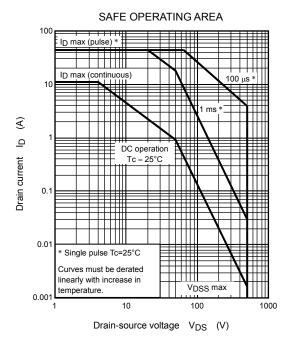


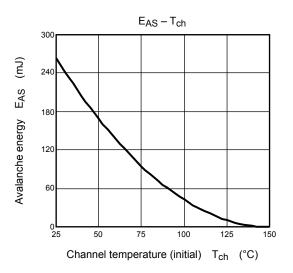
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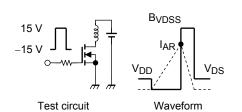
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Gate threshold voltage









$$R_G = 25~\Omega$$
 
$$V_{DD} = 90~V,~L = 3.7~mH$$

$$\mathsf{EAS} = \frac{1}{2} \cdot L \cdot l^2 \cdot \left( \frac{\mathsf{BVDSS}}{\mathsf{BVDSS} - \mathsf{VDD}} \right)$$

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